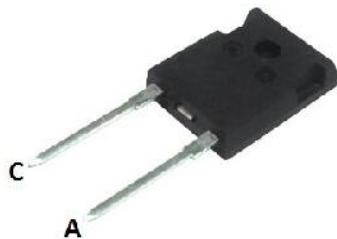


Fast Recovery 60A, 600V Epitaxial Diodes, in TO247 Package

APPLICATIONS

- Freewheeling diode (FWD)
- Snubber diode
- Clamp diode
- Power factor correction (PFC)
- Plating power supply
- Ultrasonic cleaner and welder
- Converter and chopper
- Uninterruptible power supplies
- High speed rectifiers
- Inductive heating and melting applications



FEATURES

- Ultrafast recovery time
- Soft recovery characteristics
- Low recovery loss
- Low forward voltage
- High surge current capability
- Low leakage current
- Pb-free finished; **RoHS compliant**

MAXIMUM RATINGS

Parameter	Symbol	Value	Units
Repetitive peak reverse voltage	V_{RRM}	600	V
Average forward current $T_C = 110^\circ\text{C}$	$I_{F(AV)}$	60	A
Surge non-repetitive forward current $T_J = 45^\circ\text{C}, t_p = 10 \text{ ms}, 50\text{Hz, Sine}$	I_{FSM}	600	
Power dissipation	P_D	250	W
Operating junction and storage temperature	T_J, T_{stg}	-40... +150	$^\circ\text{C}$

Thermal and Isolation Characteristics

Parameter	Symbol	Max. Value	Units
Characteristics			
Thermal resistance, junction to case	R_{thJC}	0.5	$^\circ\text{C/W}$

Electrical Characteristics, at $T_J = 25^\circ\text{C}$, unless otherwise specified

Parameter	Symbol	Value			Unit
		Min.	Typ.	Max.	
Static Characteristics					
Reverse leakage current $V_R = 600\text{V}, T_J = 25^\circ\text{C}$ $V_R = 600\text{V}, T_J = 150^\circ\text{C}$	I_R	- -	- -	250 1000	μA
Forward voltage drop $I_F = 60\text{A}, T_J = 25^\circ\text{C}$ $I_F = 60\text{A}, T_J = 150^\circ\text{C}$	V_F	- -	1.3 1.1	1.8 -	V

Electrical Characteristics, at $T_j = 25^\circ\text{C}$, unless otherwise specified

Parameter	Symbol	Value			Unit
		Min.	Typ.	Max.	
Dynamic Characteristics					
Reverse recovery time $V_R = 30V$, $I_F = 1A$, $di_F/dt = -200A/\mu\text{s}$	t_{rr}	-	38	-	ns
$V_R = 300V$, $I_F = 60A$, $di_F/dt = -200A/\mu\text{s}$, $T_j=25^\circ\text{C}$		-	54	-	
$V_R = 300V$, $I_F = 60A$, $di_F/dt = -200A/\mu\text{s}$, $T_j = 150^\circ\text{C}$		-	208	-	
Reverse recovery charge $V_R = 300V$, $I_F = 60A$, $di_F/dt = -200A/\mu\text{s}$, $T_j=25^\circ\text{C}$	Q_{rr}	-	148	-	nC
$V_R = 300V$, $I_F = 60A$, $di_F/dt = -200A/\mu\text{s}$, $T_j = 150^\circ\text{C}$		-	2.20	-	μC
Maximum reverse recovery current $V_R = 300V$, $I_F = 60A$, $di_F/dt = -200A/\mu\text{s}$, $T_j=25^\circ\text{C}$	I_{rrm}	-	6	-	A
$V_R = 300V$, $I_F = 60A$, $di_F/dt = -200A/\mu\text{s}$, $T_j = 150^\circ\text{C}$		-	17	-	

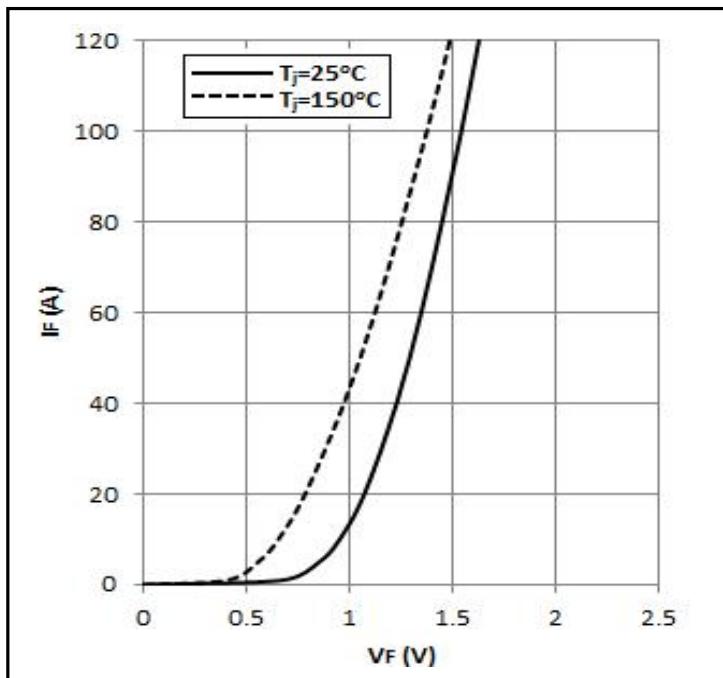
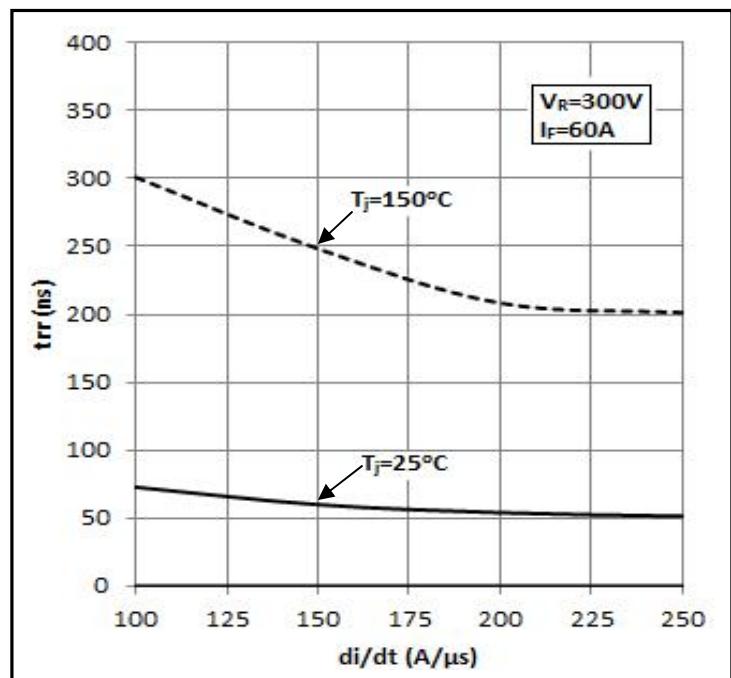
Figure 1 – Typical Forward voltage drop vs forward current

Figure 2 – Reverse recovery time vs di_F/dt


Figure 3 – Reverse recovery charge vs di_F/dt

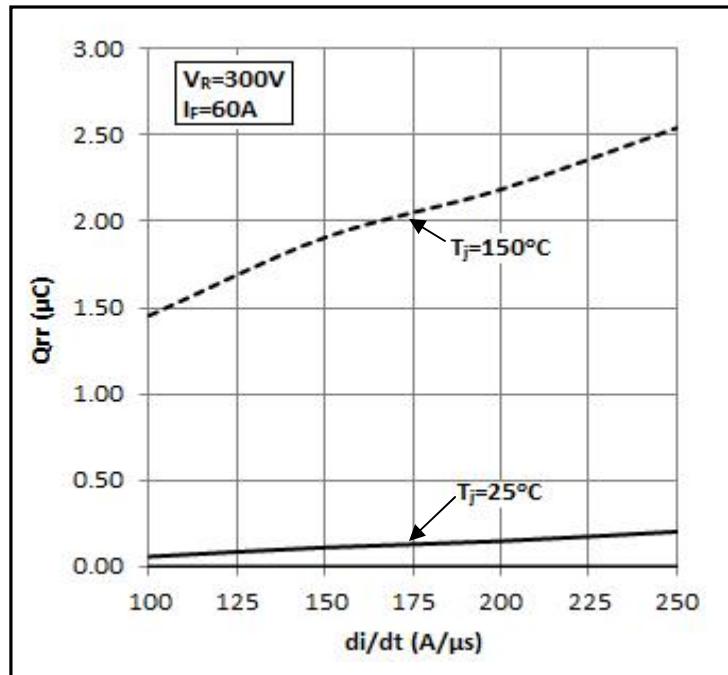


Figure 4 – Reverse recovery current vs di_F/dt

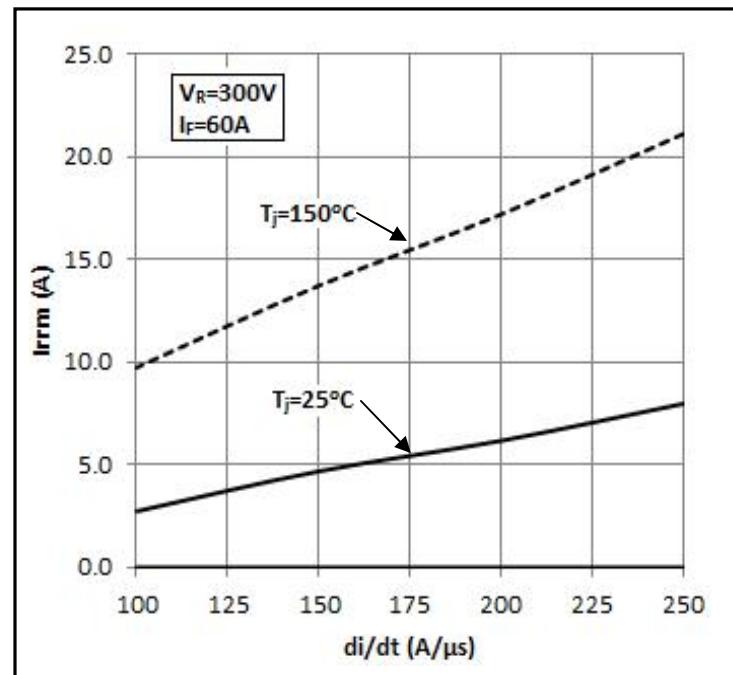
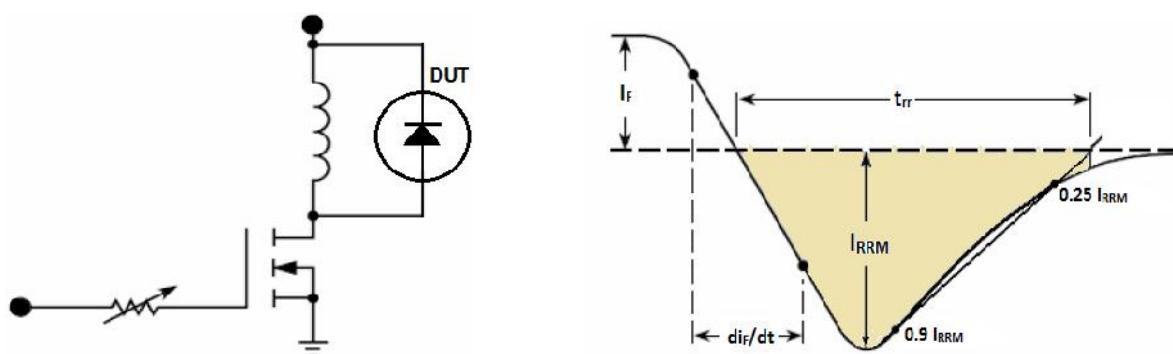
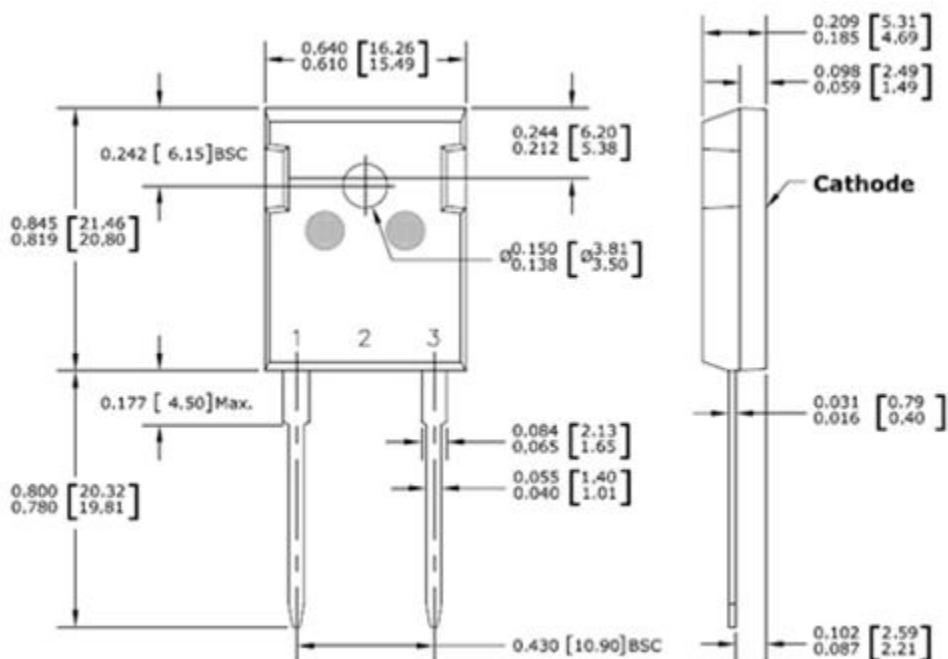


Figure 5 – Diode Reverse Recovery Test Circuit and Waveform



Package Outline Drawing



Disclaimer

These specifications may not be considered as a guarantee of components characteristics. Components have to be tested depending on intended application as adjustments may be necessary. The use of **iQXPRZ Power Inc.** components in life support appliances and systems are subject to written approval of **iQXPRZ Power Inc.**